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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SEUNGWON LEE	12/24/2019
NAMHYUNG KIM	12/24/2019
HANMIN PARK	12/24/2019
KIYOUNG CHOI	12/24/2019

RECEIVING PARTY DATA

Name:	SAMSUNG ELECTRONICS CO., LTD.
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU, GYEONGGI-DO
City:	SUWON-SI
State/Country:	KOREA, REPUBLIC OF
Postal Code:	16677
Name:	SEOUL NATIONAL UNIVERSITY R&DB FOUNDATION
Street Address:	1, GWANAK-RO, GWANAK-GU
City:	SEOUL
State/Country:	KOREA, REPUBLIC OF
Postal Code:	08826

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	16843199	

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 202-429-0020 Email: pto@nsiplaw.com

Correspondent Name: NSIP LAW

Address Line 1: P.O. BOX 65745

Address Line 4: WASHINGTON, D.C. 20035

ATTORNEY DOCKET NUMBER: 012055.0479

NAME OF SUBMITTER: THOMAS J. MATIKAINEN

PATENT REEL: 052345 FRAME: 0258

SIGNATURE:	/Thomas J. Matikainen/		
DATE SIGNED:	04/08/2020		
Total Attachments: 3	Fotal Attachments: 3		
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PATENT REEL: 052345 FRAME: 0259

COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

DECLARATION

As a below-named inver	ntor, I hereby declare that this declaration is directed to the application attached hereto, or
to United States Applica	tion Number or PCT International Application Number
filed on	(if applicable), entitled:
	METHOD AND APPARATUS WITH DATA PROCESSING

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the above-identified application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

I have reviewed and understand the contents of the above-identified application, including the claims.

I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR 1.56, including for continuation-in-part applications, material information that became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

ASSIGNMENT

For valuable consideration, I, as a below-named assignor, hereby assign to:

Samsung Electronics Co., Ltd. 129, Samsung-ro, Yeongtong-gu Suwon-si, Gyeonggi-do 16677 Republic of Korea

Seoul National University R&DB Foundation 1, Gwanak-ro, Gwanak-gu Seoul, 08826 Republic of Korea

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title, and interest throughout the world in the inventions and improvements that are the subject of the application identified in the above declaration, which is United States Application Number or PCT International Application Number 16/843,199

filed on April 8, 2020

I authorize and request the attorneys appointed in the above-identified application to hereafter complete this Assignment by inserting above the application number and the filing date of the above-identified application when known, and to correct any typographical errors that may be discovered in this Assignment.

This Assignment includes the above-identified application, any and all United States and foreign patents, utility models, and design registrations granted for any of the inventions and improvements that are the subject of the above-identified application, and the right to claim priority based on the filing date of the above-identified

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COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and I authorize the Assignee to apply in all countries in my name or in its own name for patents, utility models, design registrations, like rights of exclusion, and inventors' certificates for any of the inventions and improvements that are the subject of the above-identified application; and I agree for myself and my heirs, legal representatives, and assigns without further compensation to perform such lawful acts and to sign such further applications, Assignments, preliminary statements, and other lawful documents as the Assignee may reasonably request to effectuate fully this Assignment.

In witness whereof, I, as a below-named inventor and assignor, intending to be legally bound, have hereunto affixed my signature on the date indicated below next to my signature.

Inventor's Legal Name	Seungwon LEE	•	
Inventor's Signature		Date	DEC 246 3019
Residence (City, Country)	Hwaseong-si, Republic of Korea		
Mailing Address	c/o Samsung Advanced Institute of Technology, 130 Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16678, Republic of Korea		

Inventor's Legal Name	Namhyung KIM		
Inventor's Signature	NYE	Date	DEC. 24, 2019
Residence (City, Country)	Seoul, Republic of Korea		
Mailing Address	c/o Secul National University R&DB Foundation, 1, Gwanak-ro, Gwanak-gu, Secul, 08826. Republic of Korea		

Inventor's Legal Name	Hanmin PARK		
Inventor's Signature	Hannin Park	Date	DEC. 24, 2019
Residence (City, Country)	Seoul, Republic of Korea	/	·
Mailing Address	c/o Seoul National University R&DB Foundation Republic of Korea	i, 1, Gwa	anak-ro, Gwanak-gu, Seoul, 08826,

COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

Inventor's Legal Name	Kiyoung CHOI
Inventor's Signature	Kyrnylli Date Dec. 2x, 2019
Residence (City, Country)	Seoul, Republic of Korsa
Mailing Address	c/o Seoul National University R&DB Foundation, 1, Gwanak-ro, Gwanak-gu, Seoul, 08828, Republic of Korea

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